

MN4528B/MN4528BS

Dual Monostable Multivibrator

■ Outline

The MN4528B/S is a monostable multivibrator having two builtin circuits in one chip, and has a retrigger function and a reset function.


The monostable output pulse width is decided by the time constants of the external resistor R_t and the external condenser C_t , and the range of the output pulse width which can set is wide enough.


When the level of the \bar{C}_D input is "H" and the level of the I_1 is "L", the positive positive pulse is obtainable on the output (O) at the fall of the \bar{I}_0 input, and when the level of the C_D input is "H" and the level of the \bar{I}_0 input is "H", the negative pulse is obtainable on the output (\bar{O}) at the rise of the I_1 input.

When the level of the \bar{C}_D input is "L", the level of the output (O) is kept to "L" and the level of the output (\bar{O}) is kept to "H".

This dual monostable multivibrator is equivalent to Motorola's MC14528B.

Pin description

$\bar{I}_{0A}, \bar{I}_{0B}$: Negative input ()

I_{1A}, I_{1B} : Positive input ()

$\bar{C}_{DA}, \bar{C}_{DB}$: Clear input

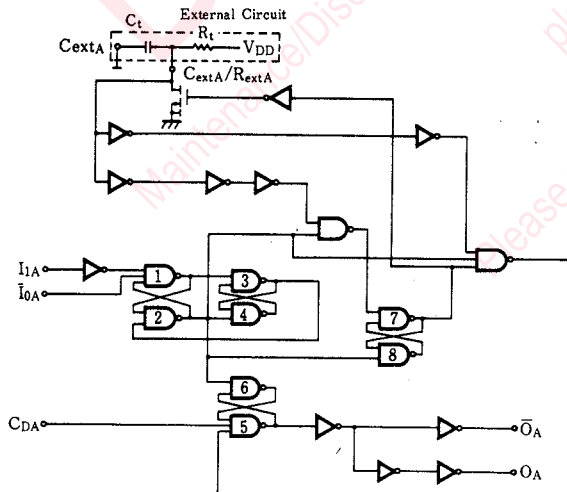
C_{extA}, C_{extB} : External capacitor connecting

$C_{ext}/R_{extA}, C_{ext}/R_{extB}$: Resistance connection

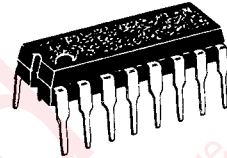
O_A, O_B : Positive output

\bar{O}_A, \bar{O}_B : Negative output

■ Logic Diagram

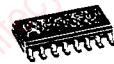


P-3



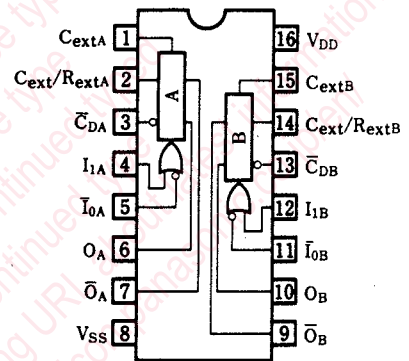
16-pin plastic DIL package

P-4



16-pin PANAFLAT package (SO-16D)

Pin Configuration



■ Truth Table

Input			Output	
I_i	\bar{I}_o	\bar{C}_D	O	\bar{O}
	H	H		
	L	H	L	H
H		H	L	H
L		H		
x	x	L	L	H

Note) x: don't care

■ Absolute Maximum Ratings (Ta=25°C)

Item	Symbol	Rating	Unit
Supply voltage	V_{DD}	-0.5~+18	V
Input voltage	V_i	-0.5~ $V_{DD}+0.5^*$	V
Output pin voltage	V_o	-0.5~ $V_{DD}+0.5^*$	V
Peak input · output pin current	$\pm I_i$	max. 10	mA
Power dissipation (per package)	P_D	max. 400	mW
		Decrease to 200mW at the rate of 8mW/°C	
Power dissipation (per output pin)	P_D	max. 100	mW
Operating ambient temperature	T_{opr}	-40~+85	°C
Storage temperature	T_{stg}	-65~+150	°C

* $V_{DD}+0.5V$ should be lower than 18V.

■ DC Characteristics ($V_{SS}=0V$)

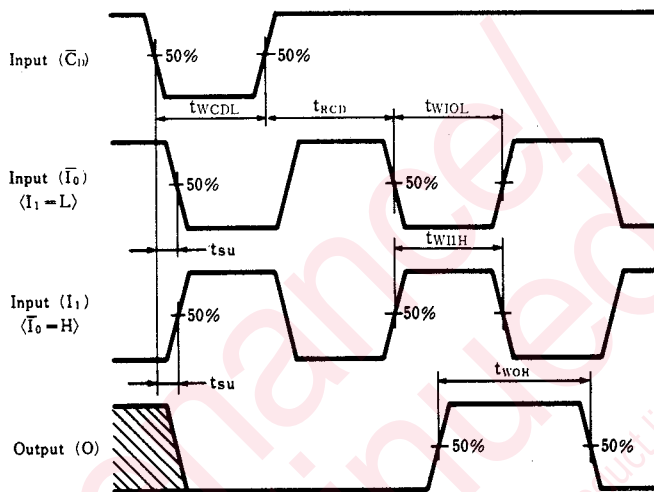
Item	V_{DD} (V)	Symbol	Condition	Ta=-40°C		Ta=25°C		Ta=85°C		Unit	
				min.	max.	min.	max.	min.	max.		
Static supply current	5	I_{DD}	$V_i=V_{SS}$ or V_{DD}	—	20	—	20	—	150	μA	
	10			—	40	—	40	—	300		
	15			—	80	—	80	—	600		
Output voltage low level	5	V_{OL}	$V_i=V_{SS}$ or V_{DD} $ I_{O1} <1\mu A$	—	0.05	—	0.05	—	0.05	V	
	10			—	0.05	—	0.05	—	0.05		
	15			—	0.05	—	0.05	—	0.05		
Output voltage high level	5	V_{OH}	$V_i=V_{SS}$ or V_{DD} $ I_{O1} <1\mu A$	4.95	—	4.95	—	4.95	—	V	
	10			9.95	—	9.95	—	9.95	—		
	15			14.95	—	14.95	—	14.95	—		
Input voltage low level	5	V_{IL}	$ I_{O1} <1\mu A$	$V_o=0.5V$ or $4.5V$ $V_o=1V$ or $9V$ $V_o=1.5V$ or $13.5V$	—	1.5	—	1.5	—	1.5	V
	10				—	3	—	3	—	3	
	15				—	4	—	4	—	4	
Input voltage high level	5	V_{IH}	$ I_{O1} <1\mu A$	$V_o=0.5V$ or $4.5V$ $V_o=1V$ or $9V$ $V_o=1.5V$ or $13.5V$	3.5	—	3.5	—	3.5	—	V
	10				7	—	7	—	7	—	
	15				11	—	11	—	11	—	
Output current low level	5	I_{OL}	$V_o=0.4V, V_i=0$ or $5V$ $V_o=0.5V, V_i=0$ or $10V$ $V_o=1.5V, V_i=0$ or $15V$	0.52	—	0.44	—	0.36	—	mA	
	10			1.3	—	1.1	—	0.9	—		
	15			3.6	—	3	—	2.4	—		
Output current high level	5	$-I_{OH}$	$V_o=4.6V, V_i=0$ or $5V$ $V_o=9.5V, V_i=0$ or $10V$ $V_o=13.5V, V_i=0$ or $15V$	0.52	—	0.44	—	0.36	—	mA	
	10			1.3	—	1.1	—	0.9	—		
	15			3.6	—	3	—	2.4	—		
Output current high level	5	$-I_{OH}$	$V_o=2.5V, V_i=0$ or $5V$	1.7	—	1.4	—	1.1	—	mA	
Input leakage current	15	$\pm I_i$	$V_i=0$ or $15V$	—	0.3	—	0.3	—	1	μA	

■ Switching Characteristics (Ta=25°C, V_{SS}=0V, C_L=50pF)

Item	V _{DD} (V)	Symbol	min.	typ.	max.	Unit
Output rise time	5	t _{TLH}	—	60	180	ns
	10		—	30	90	
	15		—	20	60	
Output fall time	5	t _{THL}	—	60	180	ns
	10		—	30	90	
	15		—	20	60	
Propagation time I ₀ , I ₁ →O	5	t _{PLH}	—	155	465	ns
	10		—	60	180	
	15		—	40	120	
Propagation time I ₀ , I ₁ → \bar{O}	5	t _{PHL}	—	140	420	ns
	10		—	50	150	
	15		—	35	105	
Propagation time C _D →O	5	t _{PHL}	—	105	315	ns
	10		—	40	120	
	15		—	30	90	
Propagation time C _D → \bar{O}	5	t _{PLH}	—	120	360	ns
	10		—	50	150	
	15		—	35	105	
Minimum pulse width I ₀	5	t _{w10L}	—	25	75	ns
	10		—	15	45	
	15		—	10	30	
Minimum pulse width I ₁	5	t _{w11L}	—	25	75	ns
	10		—	15	45	
	15		—	10	30	
Minimum pulse width C _D	5	t _{wCDL}	—	30	90	ns
	10		—	15	45	
	15		—	10	30	
Output pulse width (R _t =5kΩ, C _t =15pF)	5	t _{wOH}	—	235	—	ns
	10		—	155	—	
	15		—	140	—	
Output pulse width (R _t =10kΩ, C _t =1000pF)	5	t _{wOH}	—	5.45	—	μs
	10		—	4.95	—	
	15		—	4.85	—	
Input capacitance		C _i	—	—	7.5	pF
External timing resistance		R _t	5	—	1000	kΩ
External timing capacitance ^(Note)		C _t	—	—	10	μF

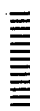
Note) When C_t is big capacitance as 0.1 – 10μF, add silicon diode (cathode side to V_{DD}) in parallel to R_t and use.

• Switching waveforms



Waveforms showing minimum T_0 , I_1 and O pulse widths, set-up and recovery times. Set-up and recovery times are shown as positive values but may be specified as negative values.

Maintenance/Discontinued includes following your Product lifecycle stage.
 planned maintenance type
 maintenance type
 planned discontinued type
 discontinued type
 Please visit following URL about latest information.
<http://www.semicon.panasonic.co.jp/en/>



Request for your special attention and precautions in using the technical information and semiconductors described in this book

- (1) If any of the products or technical information described in this book is to be exported or provided to non-residents, the laws and regulations of the exporting country, especially, those with regard to security export control, must be observed.
- (2) The technical information described in this book is intended only to show the main characteristics and application circuit examples of the products. No license is granted in and to any intellectual property right or other right owned by Panasonic Corporation or any other company. Therefore, no responsibility is assumed by our company as to the infringement upon any such right owned by any other company which may arise as a result of the use of technical information described in this book.
- (3) The products described in this book are intended to be used for standard applications or general electronic equipment (such as office equipment, communications equipment, measuring instruments and household appliances).
Consult our sales staff in advance for information on the following applications:
 - Special applications (such as for airplanes, aerospace, automobiles, traffic control equipment, combustion equipment, life support systems and safety devices) in which exceptional quality and reliability are required, or if the failure or malfunction of the products may directly jeopardize life or harm the human body.
 - Any applications other than the standard applications intended.
- (4) The products and product specifications described in this book are subject to change without notice for modification and/or improvement. At the final stage of your design, purchasing, or use of the products, therefore, ask for the most up-to-date Product Standards in advance to make sure that the latest specifications satisfy your requirements.
- (5) When designing your equipment, comply with the range of absolute maximum rating and the guaranteed operating conditions (operating power supply voltage and operating environment etc.). Especially, please be careful not to exceed the range of absolute maximum rating on the transient state, such as power-on, power-off and mode-switching. Otherwise, we will not be liable for any defect which may arise later in your equipment.
 - Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.
- (6) Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.
- (7) This book may be not reprinted or reproduced whether wholly or partially, without the prior written permission of our company.